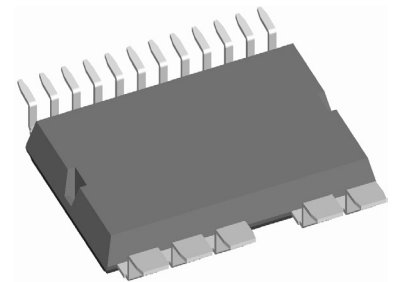
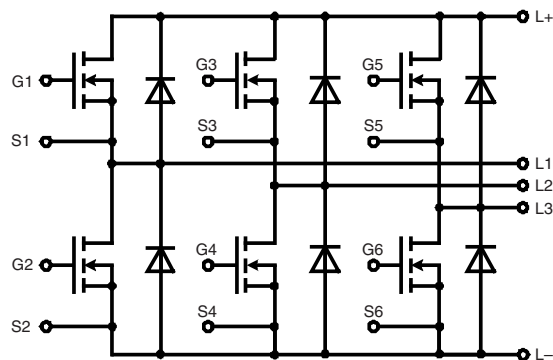


Three phase full Bridge with Trench MOSFETs in DCB-isolated high-current package

$$\begin{aligned}
 V_{DSS} &= 100 \text{ V} \\
 I_{D25} &= 120 \text{ A} \\
 R_{DSon \text{ typ.}} &= 3.2 \text{ m}\Omega
 \end{aligned}$$

Part number
MTI85W100GC



Surface Mount Device

Features / Advantages:

- MOSFETs in trench technology:
 - low R_{DSon}
 - optimized intrinsic reverse diode
- Package:
 - high level of integration
 - high current capability (300 A max.)
 - aux. terminals for MOSFET control
 - terminals for soldering or welding connections
 - isolated DCB ceramic base plate with optimized heat transfer
- Space and weight savings

Applications:

- AC drives
 - in automobiles
 - electric power steering
 - starter generator
 - in industrial vehicles
 - propulsion drives
 - fork lift drives
 - in battery supplied equipment

Package: ISOPLUS-DIL®

- High level of integration
- RoHS compliant
- High current capability
- Aux. Terminals for MOSFET control
- Terminals for soldering or welding connections
- Space and weight savings

Terms & Conditions of usage

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office.

Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

- to perform joint risk and quality assessments;

- the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, test conditions and dimensions.

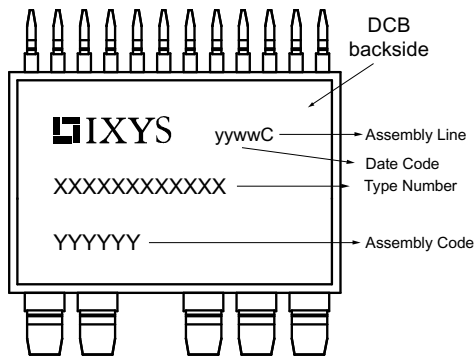
20170614g

© 2017 IXYS All rights reserved

1 - 7

MOSFETs				Ratings			
Symbol	Definitions	Conditions		min.	typ.	max.	Unit
V _{DSS}	drain source breakdown voltage	T _{VJ} = 25°C to 150°C				100	V
V _{GS}	gate source voltage					±15	V
V _{GSM}	max. transient gate source voltage					±20	V
I _{D25}	continuous drain current	T _C = 25°C				120	A
I _{D90}		T _C = 90°C				90	A
I _{F25}	forward current	T _C = 25°C					A
I _{F90}		T _C = 90°C					A
R _{DS(on)} ¹⁾	static drain source on resistance	on-chip level at I _D = 80 A; V _{GS} = 10 V	T _{VJ} = 25°C T _{VJ} = 125°C	3.2 5.4	4	mΩ mΩ	
V _{GS(th)}	gate threshold voltage	I _D = 150 μA; V _{DS} = V _{GS}	T _{VJ} = 25°C	2.0		3.5	V
I _{DSS}	drain source leakage current	V _{DS} = V _{DSS} ; V _{GS} = 0 V	T _{VJ} = 25°C T _{VJ} = 125°C		10	1 100	μA μA
I _{GSS}	gate source leakage current	V _{GS} = ±20 V; V _{DS} = 0 V				500	nA
R _G	gate resistance	on-chip level					Ω
Q _g	total gate charge	V _{GS} = 10 V; V _{DS} = 50 V; I _D = 80 A		88			nC
Q _{gs}	gate source charge			30			nC
Q _{gd}	gate drain (Miller) charge			18			nC
t _{d(on)}	turn-on delay time	inductive load V _{GS} = 10 V; V _{DS} = 50 V I _D = 80 A; R _G = 39 Ω	T _{VJ} = 125°C	90			ns
t _r	current rise time			55			ns
t _{d(off)}	turn-off delay time			480			ns
t _f	current fall time			40			ns
E _{on}	turn-on energy per pulse			130			μJ
E _{off}	turn-off energy per pulse			390			μJ
E _{rec(off)}	turn-off reverse recovery losses			10			μJ
R _{thJC}	thermal resistance junction to case					1.2	K/W
R _{thJH}	thermal resistance junction to heatsink	with heat transfer paste (IXYS test setup)		1.5			K/W
¹⁾ V _{DS} = I _D · (R _{DS(on)} + 2 · R _{Pin to Chip})							
Source-Drain Diode							
V _{SD}	source drain voltage	I _F = 80 A; V _{GS} = 0 V	T _{VJ} = 25°C	0.9		1.2	V
Q _{RM}	reverse recovery charge	V _R = 50 V; I _F = 80 A; R _G = 39 Ω di/dt = 1500 A/μs	T _{VJ} = 125°C	1.3			μC
I _{RM}	max. reverse recovery current			44			A
t _{rr}	reverse recovery time			45			ns

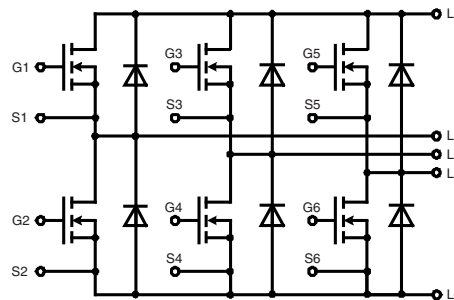
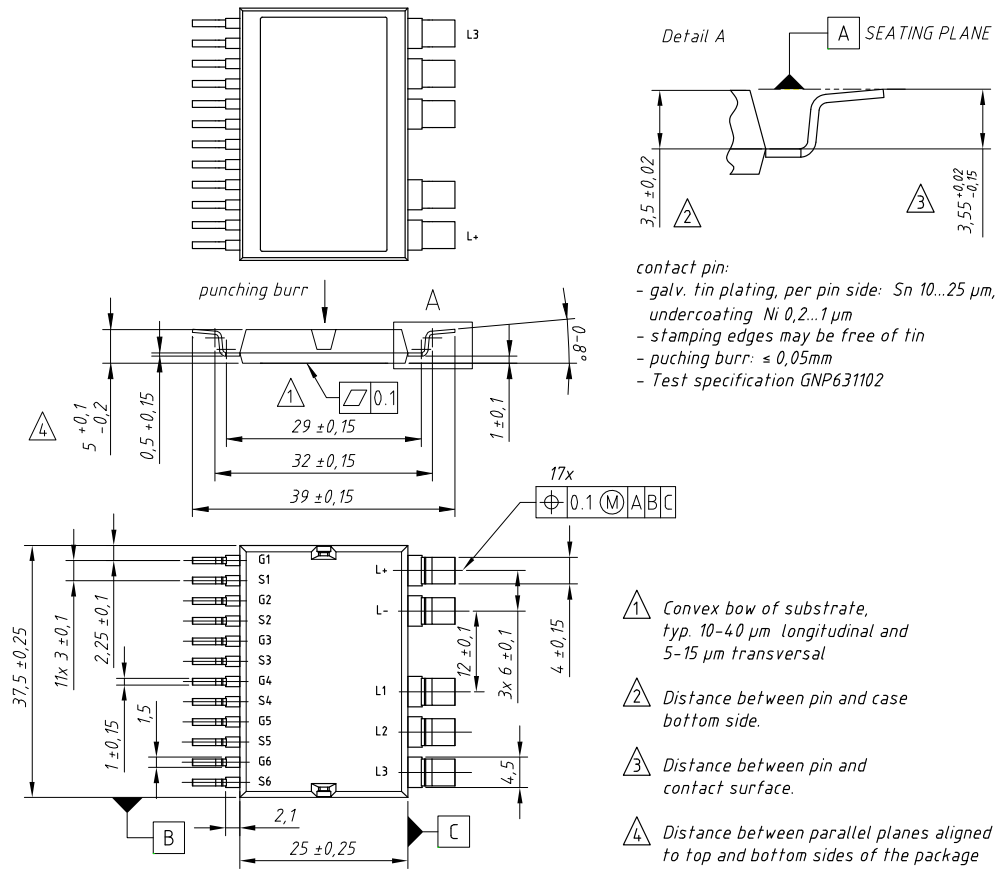
Package ISOPLUS-DIL®				Ratings			
Symbol	Definitions	Conditions		min.	typ.	max.	Unit
I _{RMS}	RMS current	per pin in main current paths (P+, N–, L1, L2, L3) may be additionally limited by external connections (PCB tracks)				300	A
T _{stg}	storage temperature			-55		125	°C
T _{op}	operation temperature			-55		150	°C
T _{VJ}	virtual junction temperature			-55		175	°C
V _{ISOL}	isolation voltage	t = 1 second	50/60 Hz, RMS, I _{ISOL} ≤ 1 mA	1200			V
		t = 1 minute		1000			V
R _{pin-chip}	resistance terminal to chip	V _{DS} = I _D •(R _{DS(on)} + 2•R _{pin to chip})			0.6		mΩ
C _P	coupling capacity	between shorted pins and back side metallization			160		pF
F _C	mounting force with clip			50		250	N
Weight					13		g


Part number

M = MOSFET
 T = Trench
 I = Infineon Trench
 85 = Current Rating [A]
 W = 6-Pack
 100 = Reverse Voltage [V]
 GC = ISOPLUS-DIL

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MTI85W100GC-SMD	MTI85W100GC	Tube	13	516941

Outlines ISOPLUS-DIL®



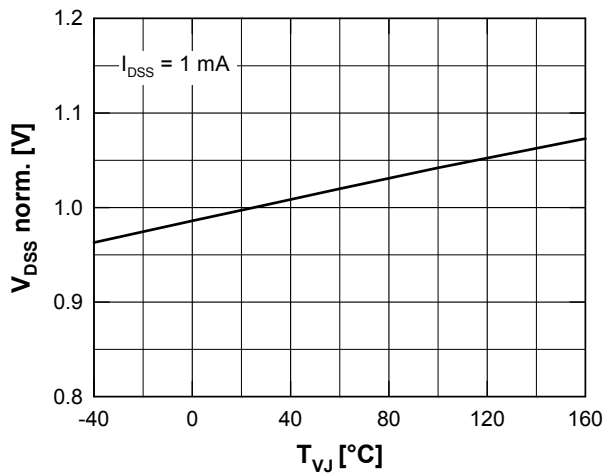


Fig. 1 Drain source breakdown voltage V_{DS} vs. junction temperature T_{VJ}

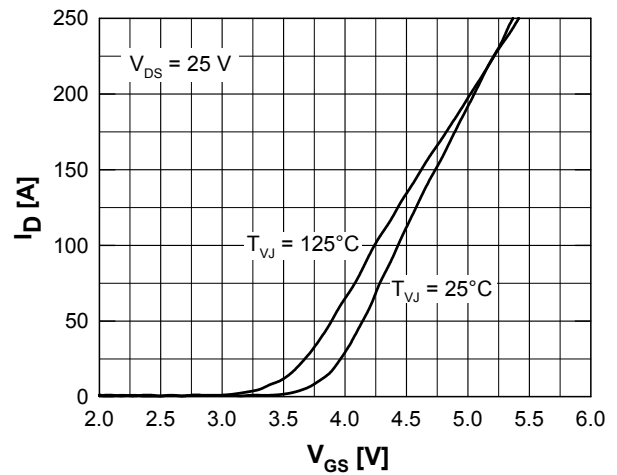


Fig. 2 Typ. transfer characteristics

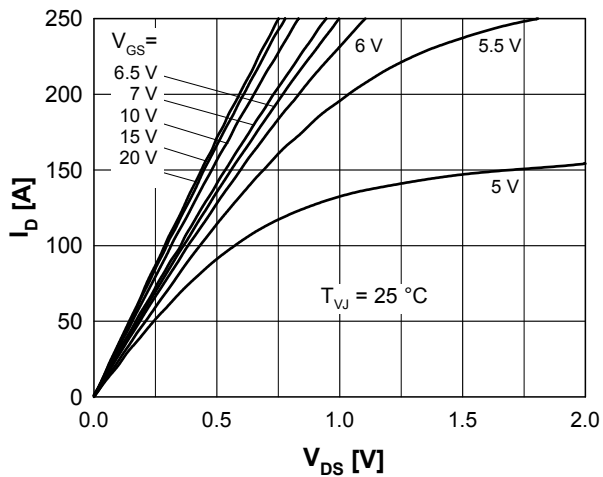


Fig. 3 Typ. output characteristics (25 °C)

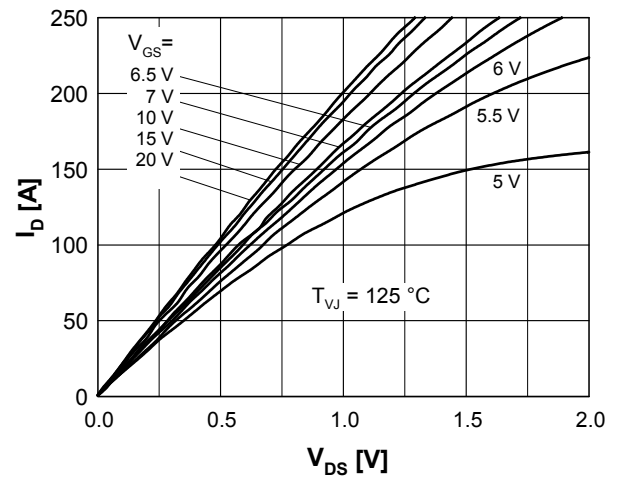


Fig. 4 Typ. output characteristics (125 °C)

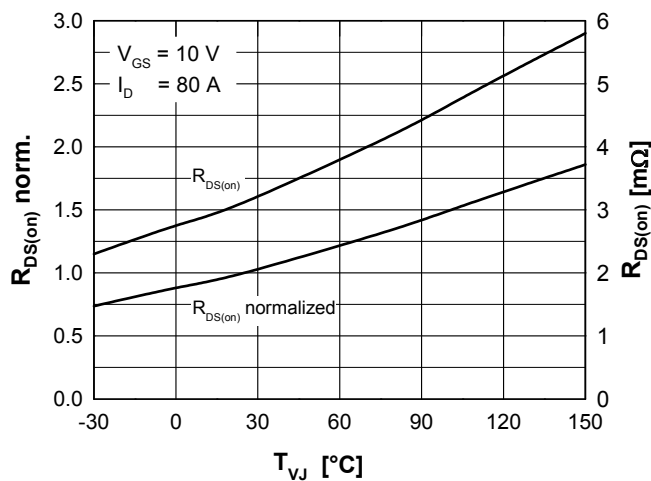


Fig. 5 Drain source on-state resistance versus junction temperature

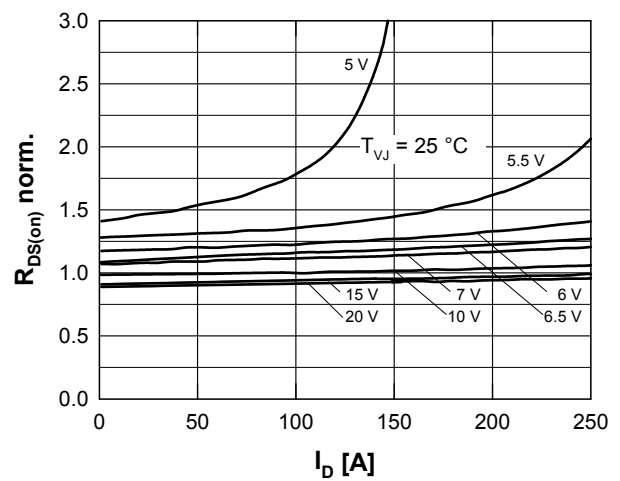


Fig. 6 Drain source on-state resistance versus I_D

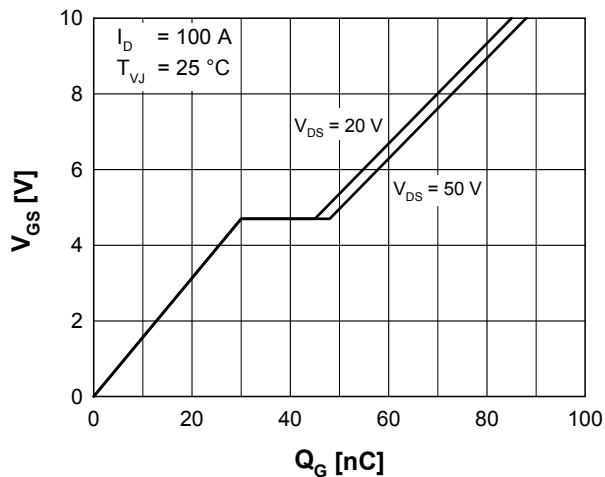


Fig. 7 Typical turn on gate charge

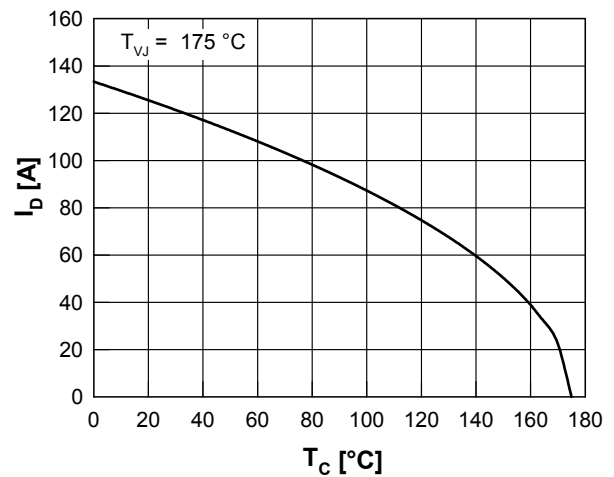


Fig. 8 Drain current I_D vs. case temperature T_C (chip capability)

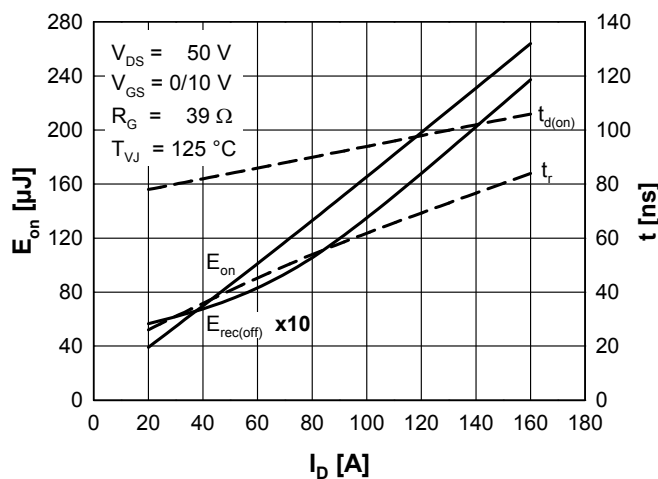


Fig. 9 Typ. turn-on energy and switching times versus drain current, inductive switching

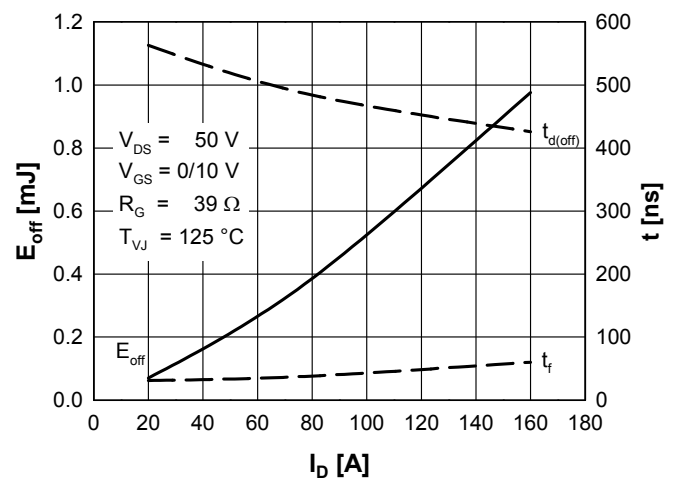


Fig. 10 Typ. turn-off energy and switching times versus drain-current, inductive switching

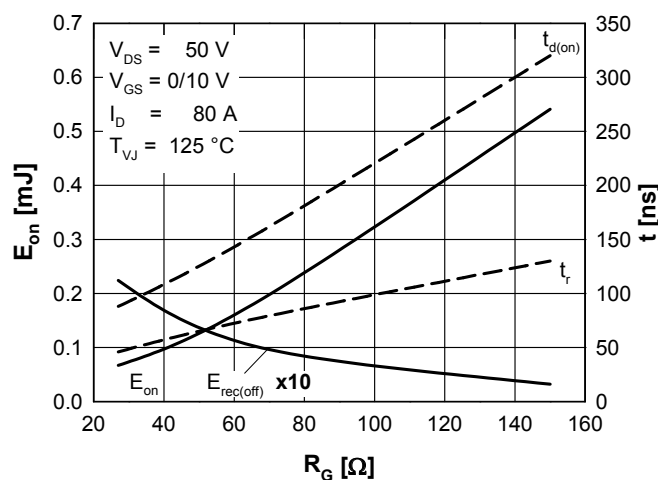


Fig. 11 Typ. turn-on energy and switching times versus gate resistor, inductive switching

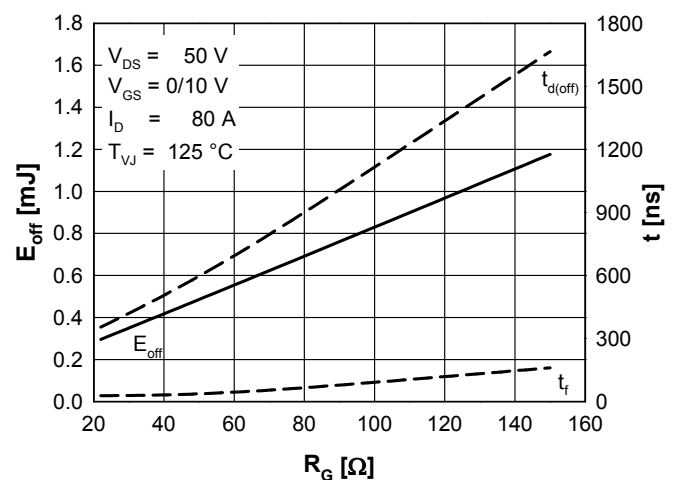


Fig. 12 Typ. turn-off energy and switching times versus gate resistor, inductive switching

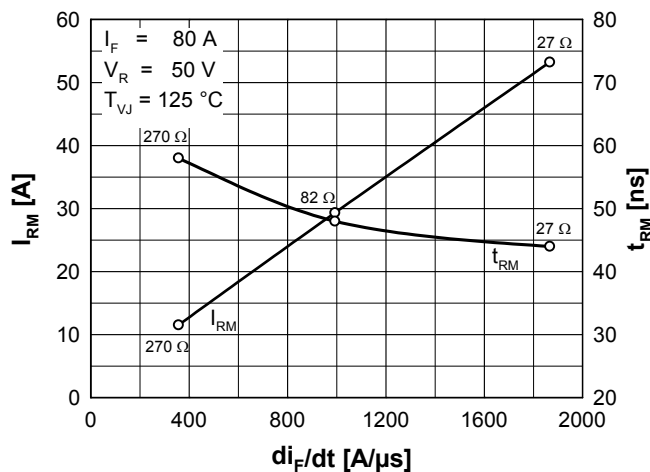


Fig. 13 Reverse recovery time t_{RM} of the body diode vs. di_F/dt

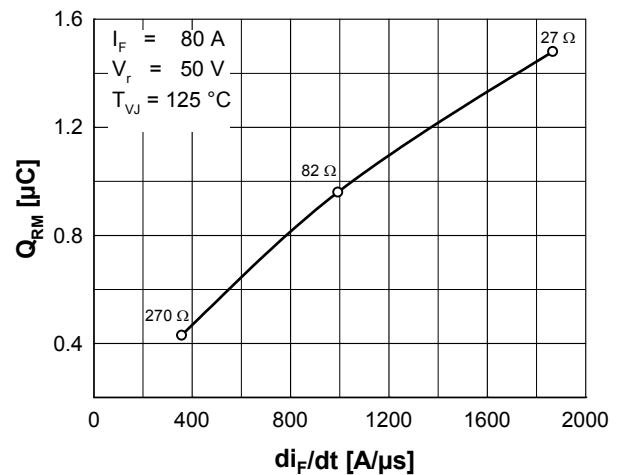


Fig. 14 Reverse recovery charge Q_{RM} of the body diode vs. di_F/dt

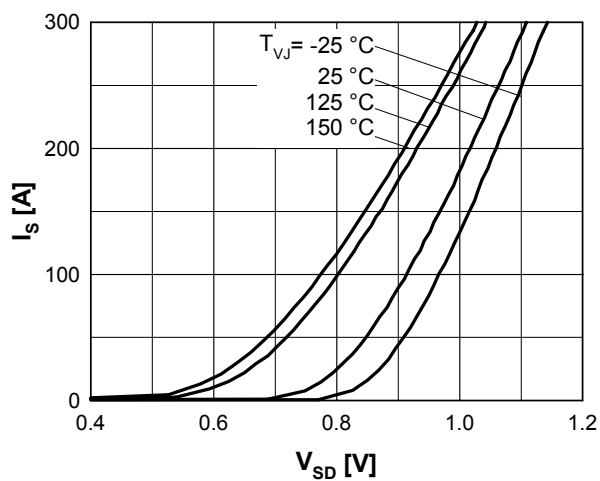


Fig. 15 Source current I_S vs. source drain voltage V_{SD} (body diode)

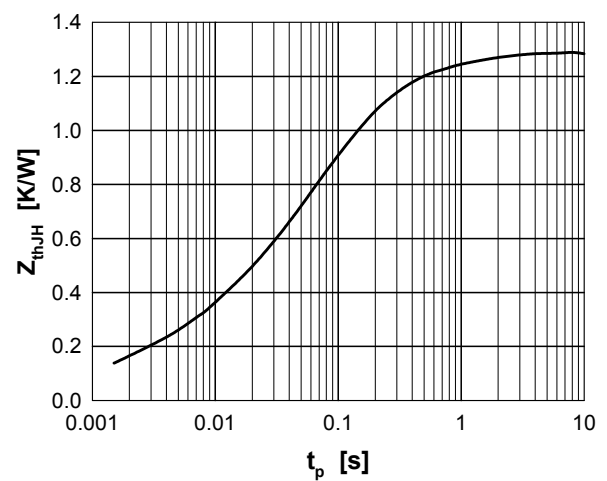


Fig. 16 Typ. thermal impedance junction to heatsink Z_{thJH} with heat transfer paste (IXYS test setup)

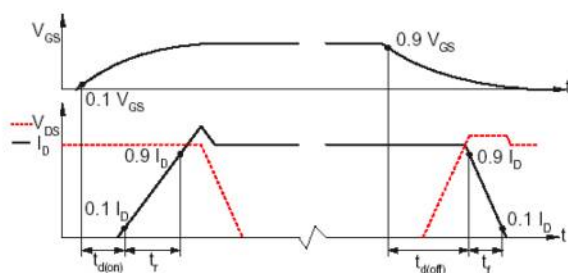


Fig. 17 Definition of switching times



**Стандарт
Электрон
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,
Промышленная ул, дом № 19, литера Н,
помещение 100-Н Офис 331